

May 1999 Revised December 1999

FSTU3384 10-Bit Bus Switch with –2V Undershoot Hardened Circuit (UHC™) Protection

General Description

The Fairchild Switch FSTU3384 provides 10 bits of high-speed CMOS TTL-compatible bus switches. The low on resistance of the switch allows inputs to be connected to outputs without adding propagation delay generating additional ground bounce noise. Both the A Ports and the B Ports are "undershoot hardened" with UHCTM protection to support an extended input range to 2.0V below ground. Fairchild's integrated Undershoot Hardened Circuit, UHC senses undershoot at the I/Os, and responds by preventing voltage differentials from developing and turning on the switch. The device is organized as two 5-bit switches with separate bus enable $\overline{(\text{OE})}$ signals. When $\overline{\text{OE}}$ is LOW, the switch is ON and Port A is connected to Port B. When $\overline{\text{OE}}$ is HIGH, the switch is OPEN and a high-impedance state exists between the two ports.

Features

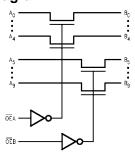
- \blacksquare 4 Ω switch connection between two ports
- Undershoot Hardened to -2.0V.
- Minimal propagation delay through the switch
- Low loc
- Zero ground bounce in flow-through mode
- Control inputs compatible with TTL level
- See Applications Note AN-5008 for details.

Ordering Code:

Order Number	Package Number	Package Description
FSTU3384WM	M24B	24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MO-153 4.4mm Wide
FSTU3384QSC	MQA24	24-Lead Quarter Size Outline Package (QSOP), JEDEC MO-137, 0.150" Wide
FSTU3384MTC	MTC24	24-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Logic Diagram



Pin Descriptions

Pin Names	Description
OEA, OEB	Bus Switch Enable
A ₀ -A ₉	Bus A
B ₀ -B ₉	Bus B

UHC™ is a trademark of Fairchild Semiconductor Corporation.

Connection Diagram



Truth Table

OEA	OEB	B ₀ -B ₄	B ₅ -B ₉	Function	
L	L	A ₀ -A ₄	A ₅ -A ₉	Connect	
L	Н	A ₀ -A ₄	HIGH-Z State	Connect	
Н	L	HIGH-Z State	A ₅ -A ₉	Connect	
Н	Н	HIGH-Z State	HIGH-Z State	Disconnect	

Absolute Maximum Ratings(Note 1)

Supply Voltage (V_{CC}) -0.5V to +7.0VDC Switch Voltage (V_S) -2.0V to +7.0V-0.5V to +7.0V DC Input Voltage (V_{IN}) (Note 2) DC Input Diode Current (I_{IK}) V_{IN} <0V-50 mA DC Output (I_{OUT}) Sink Current 128 mA DC V_{CC}/GND Current (I_{CC}/I_{GND}) +/- 100mA Storage Temperature Range (T_{STG}) $-65^{\circ}C$ to $+150^{\circ}C$

Recommended Operating Conditions (Note 3)

Power Supply Operating (V_{CC}) 4.0V to 5.5V Input Voltage (V_{IN}) 0V to 5.5V Output Voltage (V_{OUT}) 0V to 5.5V

Input Rise and Fall Time (t_r, t_f)

Switch Control Input 0nS/V to 5nS/V 0nS/V to DC Switch I/O Free Air Operating Temperature (T_A) -40°C to +85°C

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the "Electrical Characteristics" table are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

Note 3: Unused control inputs must be held HIGH or LOW. They may not

DC Electrical Characteristics

		.,	T _A = -40°C to +85°C					
Symbol	Parameter	V _{CC} (V)	Min	Typ (Note 5)	Max	Units	Condition	
V _{IK}	Clamp Diode Voltage	4.5			-1.2	٧	I _{IN} = - 18 mA	
V _{IH}	HIGH Level Input Voltage	4.0-5.5	2.0			V		
V _{IL}	LOW Level Input Voltage	4.0-5.5			0.8	٧		
I _I	Input Leakage Current	5.5			±1.0	μА	0 ≤ V _{IN} ≤ 5.5V	
l _{OZ}	OFF-STATE Leakage Current	5.5			±1.0	μА	$0 \le A, B \le V_{CC}, V_{IN} = V_{IH}$	
R _{ON}	Switch On Resistance	4.5		4	7	Ω	V _S = 0V, I _{IN} = 64 mA	
	(Note 4)	4.5		4	7	Ω	V _S = 0V, I _{IN} = 30 mA	
		4.5		8	15	Ω	V _S = 2.4V, I _{IN} = 15 mA	
		4.0		11	20	Ω	V _S = 2.4V, I _{IN} = 15 mA	
I _{CC}	Quiescent Supply Current	5.5			3	μА	V _S = V _{CC} or GND, I _{OUT} = 0	
ΔI _{CC}	Increase in I _{CC} per Input	5.5			2.5	mA	OE input at 3.4V	
							Other inputs at V _{CC} or GND	
I _{BIAS}	Bias Pin Leakage Current	5.5			±1.0	μА	OE = 0V, B = 0V, BiasV = 5.5V	
I _{OZU}	Switch Undershoot Current	5.5			100	μА	I_{IN} = - 20 mA, \overline{OE} = 5.5V, $V_{OUT} \ge V_{IH}$	
V _{IKU}	Voltage Undershoot	5.5			-2.0	V	$0.0 \text{ mA} \ge I_{\text{IN}} \ge -50 \text{ mA}, \overline{\text{OE}} = 5.5 \text{V}$	

Note 4: Measured by voltage drop between A and B pin at indicated current through the switch. On resistance is determined by the lower of the voltages on the two (A or B) pins.

Note 5: All typical values are at $V_{CC}=5.0 \, \text{V}, \, T_{A}=25^{\circ} C.$

AC Electrical Characteristics

0	Parameter	$T_A = -40$ °C to +85 °C $C_L = 50$ pF, RU = RD = 500Ω				Halfa		
Symbol		V _{CC} = 4.5 - 5.5V		$V_{CC} = 4.0V$		Units	Conditions	Figure No.
		Min	Max	Min	Max			
t _{PHL} , t _{PLH}	Prop Delay Bus to Bus (Note 6)		0.25		0.25	ns	V _I = OPEN	Figure 1, Figure 2
t _{PZH} , t _{PZL}	Output Enable Time OE _A , OE _B to A _n , B _n	1.0	5.7		6.2		$V_I = 7V$ for t_{PZL} $V_I = OPEN$ for t_{PZH}	Figure 1, Figure 2
t _{PHZ} , t _{PLZ}	Output Disable Time \overline{OE}_A , \overline{OE}_B to A _n , B _n	1.5	5.2		5.5	ns	$V_I = 7V$ for t_{PLZ} $V_I = OPEN$ for t_{PHZ}	Figure 1, Figure 2

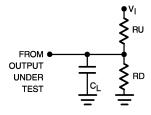
Note 6: This parameter is guaranteed by design but not tested. The bus switch contributes no propagation delay other than the RC delay of the typical On resistance of the switch and the 50pF load capacitance, when driven by an ideal voltage the source (zero output impedance).

Capacitance (Note 7)

Symbol	Parameter	Тур	Max	Units	Conditions
C _{IN}	Control Input Capacitance	3		pF	V _{CC} = 5.0V
C _{I/O} (OFF)	Input/Output Capacitance	5		pF	V_{CC} , $\overline{OE} = 5.0V$

Note 7: Capacitance is characterized but not tested.

AC Loading and Waveforms



Note: Input driven by 50 Ω source terminated in 50 $\Omega,$ RU = RD = 500 Ω

 $\label{eq:Note: CL includes load and stray capacitance, CL = 50 pF} % \begin{center} \textbf{Note:} & C_L = 50 & DF \\ \textbf{Note:} & D_L = 1.0 & D_L \\ \textbf{Note:} & D_L = 1$

FIGURE 1. AC Test Circuit

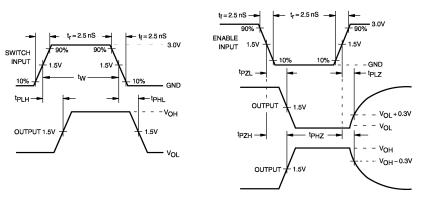
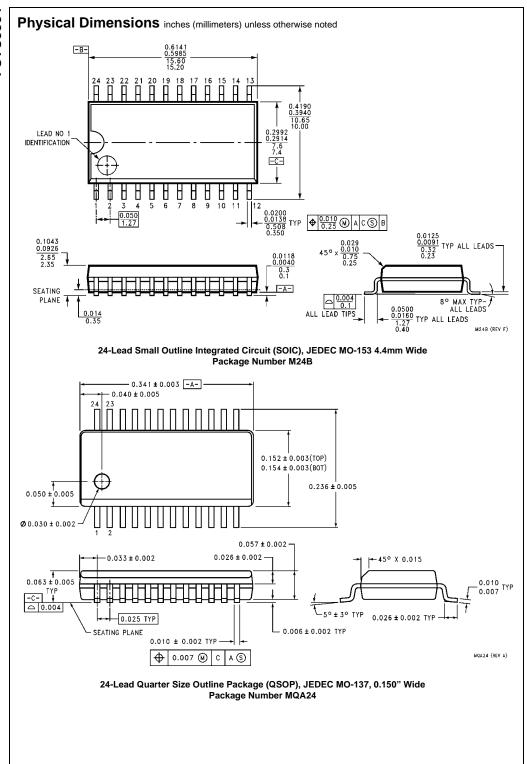
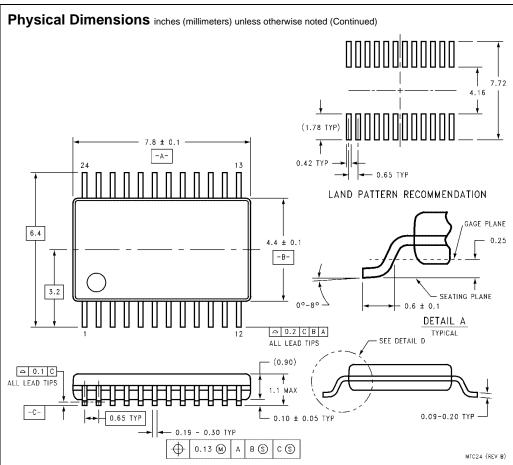


FIGURE 2. AC Waveforms





24-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC24

Technology Description

The Fairchild Switch family derives from and embodies Fairchild's proven switch technology used for several years in its 74LVX3L384 (FST3384) bus switch product.

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